# Surface Mount **T RF Transformer**

30 to 900 MHz

50Ω

#### **Features**

- wide bandwidth 30 to 900 MHz
- balanced transmission line
- excellent return loss
- aqueous washable

#### **Applications**

- PCS
- wideband push-pull amplifiers
- cellular





Generic photo used for illustration purposes only

CASE STYLE: DB1627

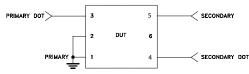
+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

	Available Tape and Reel at no extra cost
Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

#### Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit
Impedance Ratio (secondary/primary)			2		
Frequency Range		30		900	MHz
Insertion Loss	30 - 900	_	1.1	2.5	dB
Amplitude Unbalance	30 - 900	_	0.8	_	dB
Phase Unbalance	30 - 900	_	6	_	Degree

#### **Electrical Schematic**



#### **Maximum Ratings**

U			
Parameter	Ratings		
Operating Temperature	-40°C to 85°C		
Storage Temperature	-55°C to 100°C		
RF Power	0.4W		
DC Current	30mA		

Permanent damage may occur if any of these limits are exceeded.

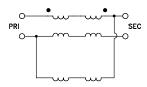
### **Product Marking**



#### Pin Connections

Function	Pin Number		
PRIMARY DOT	3		
PRIMARY	1,2		
SECONDARY DOT	4		
SECONDARY	5		
GND	1,2		
NOT USED	6		

Config. K



## TCM2-92X-1+

#### **Outline Drawing** ORIENTATION DOT MODEL MARKING (ORIENTATION) PCB Land Pattern COMPONENT AREA -D TYP D TYP E TYP TYP н G TYF TYF SUGGESTED LAYOUT TOP HAT/ PICK & PLACE SURFACE AREA (.10x.10) MIN Top-Hat total thickness: .013 inches MAX. Orientation dot on top hat & orientation TOLERANCE TO BE WITHIN ±.002 feature on substrate corresponds to pin#1 Outline Dimensions (inch )

D

030

Е

.025

0.64

0.15

wt grams

.050 .040 1.27 1.02

B C

н

065

1.65 4.83 0.76

4.06

190

J K

.150 3.81

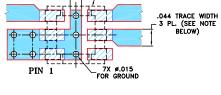
A .160 4.06

G

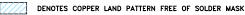
.028

0.71

# Demo Board MCL P/N: TB-717+ Suggested PCB Layout (PL-395)

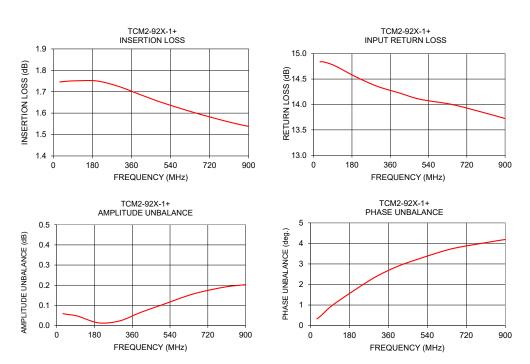


NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 0Z. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE. DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



### **Typical Performance Data**

Frequency (MHz)	Insertion Loss (dB)	Input R. Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (Deg.)
30	1.75	14.84	0.06	0.33
50	1.75	14.83	0.06	0.49
100	1.75	14.76	0.05	0.97
200	1.75	14.54	0.01	1.70
300	1.73	14.36	0.02	2.36
400	1.69	14.23	0.07	2.87
500	1.65	14.10	0.10	3.25
650	1.60	14.00	0.16	3.73
800	1.56	13.84	0.19	4.02
900	1.54	13.72	0.20	4.19



#### **Additional Notes**

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document. B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions. C. The parts covered by this specification document are subject to Mini-Circuit standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

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